# FAIRCHILD

SEMICONDUCTOR TM

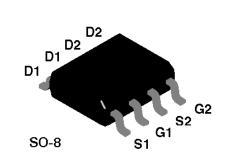
# NDS9948 Dual P-Channel Enhancement Mode Field Effect Transistor

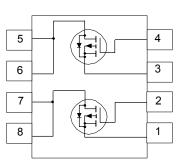
## **General Description**

These P-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, high cell density, DMOS technology. This very high density process has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulses in the avalanche and commutation modes. These devices are particularly suited for low voltage applications such as notebook computer power management and other battery powered circuits where fast switching, low in-line power loss, and resistance to transients are needed.

## Features

- -2.3A, -60V.  $R_{DS(ON)} = 0.25\Omega \otimes V_{GS} = -10V.$
- High density cell design for low R<sub>DS(ON)</sub>.
- High power and current handling capability in a widely used surface mount package.
- Dual MOSFET in surface mount package.





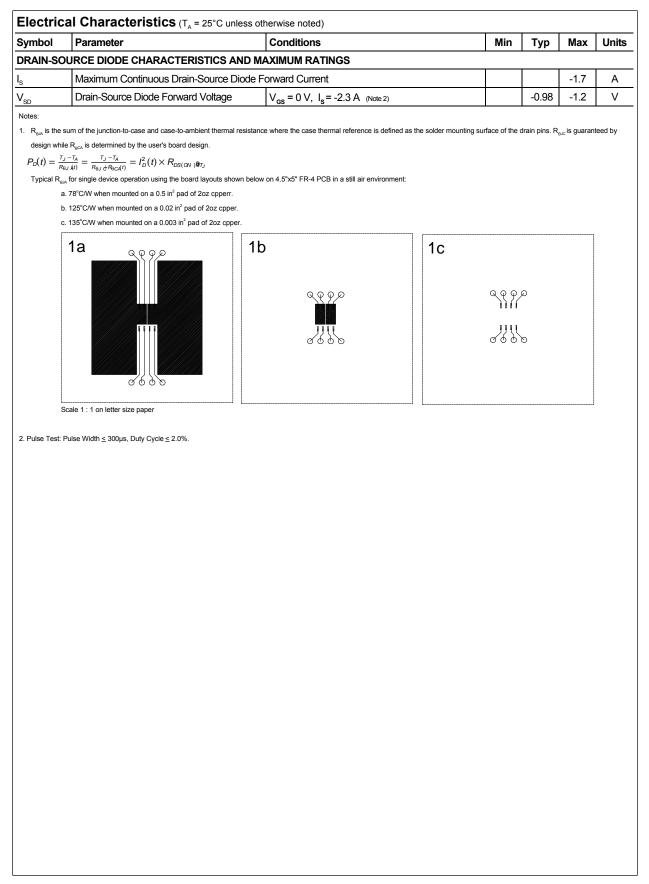
# **Absolute Maximum Ratings** $T_A = 25^{\circ}C$ unless otherwise noted

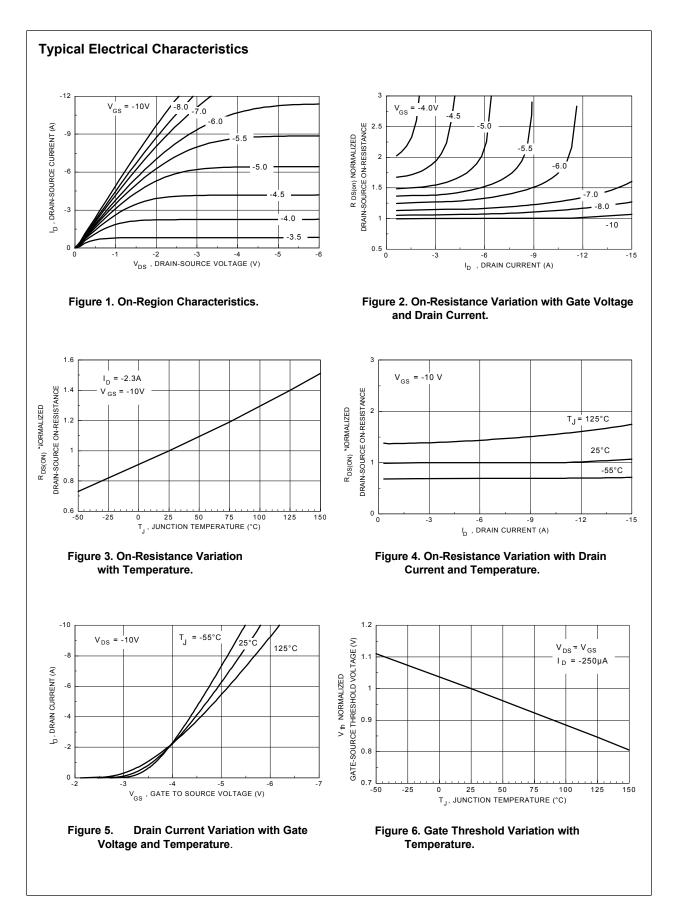
Symbol	Parameter		NDS9948	Units
V <sub>DSS</sub>	Drain-Source Voltage		-60	V
V <sub>GSS</sub>	Gate-Source Voltage		± 20	V
I <sub>D</sub>	Drain Current - Continuous $T_A = 25^{\circ}C$	(Note 1a)	± 2.3	A
	- Pulsed $T_A = 25^{\circ}C$		± 10	
	- Continuous $T_A = 70^{\circ}C$	(Note 1a)	± 1.8	
P <sub>D</sub>	Power Dissipation for Dual Operation		2	W
	Power Dissipation for Single Operation	Note 1a)	1.6	
	(I)	Note 1b)	1	
	()	Note 1c)	0.9	
T <sub>J</sub> ,T <sub>STG</sub>	Operating and Storage Temperature Range		-55 to 150	°C
THERMA	L CHARACTERISTICS			
R <sub>θJA</sub>	Thermal Resistance, Junction-to-Ambient (Note 1a)		78	°C/W
R <sub>ØJC</sub>	Thermal Resistance, Junction-to-Case	lote 1)	40	°C/W

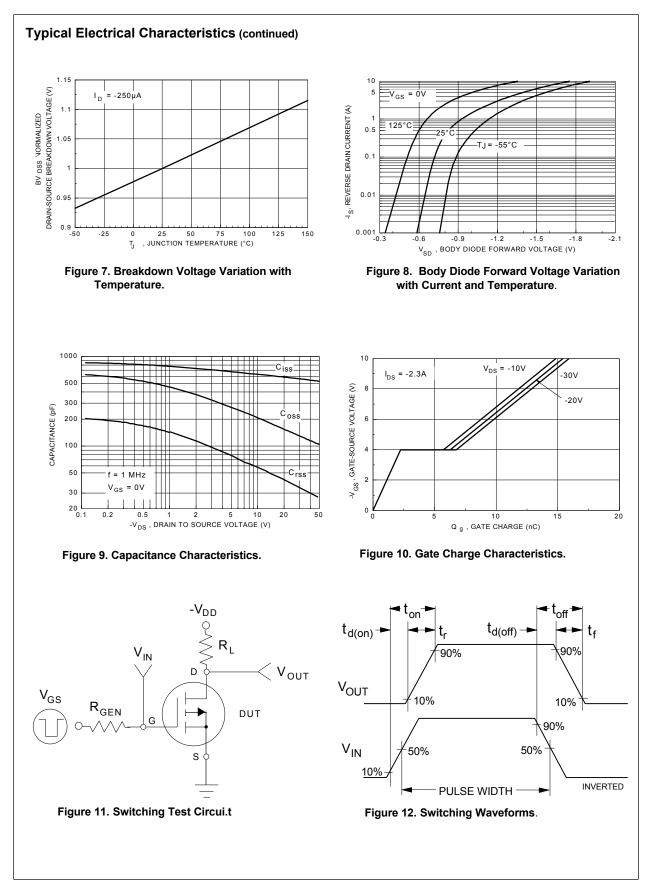
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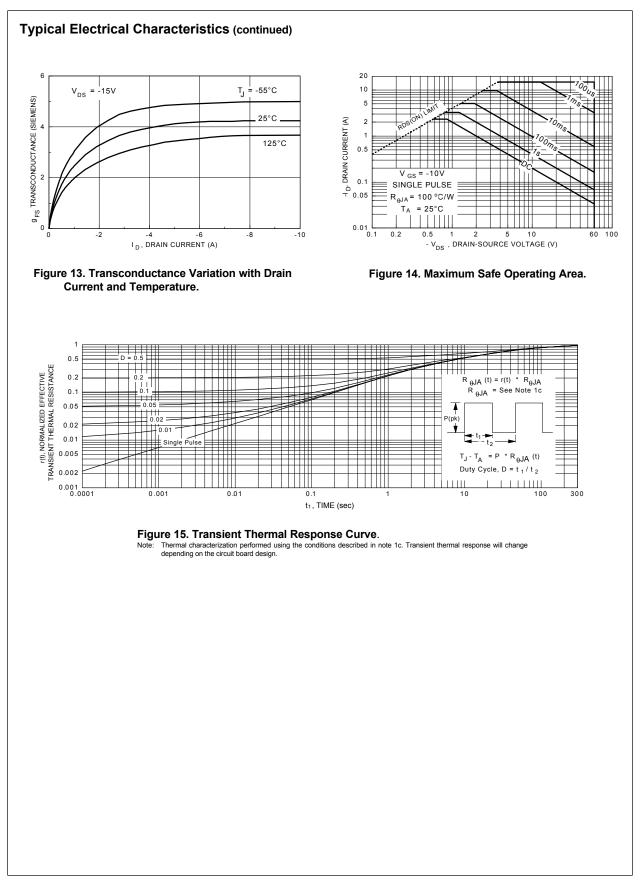
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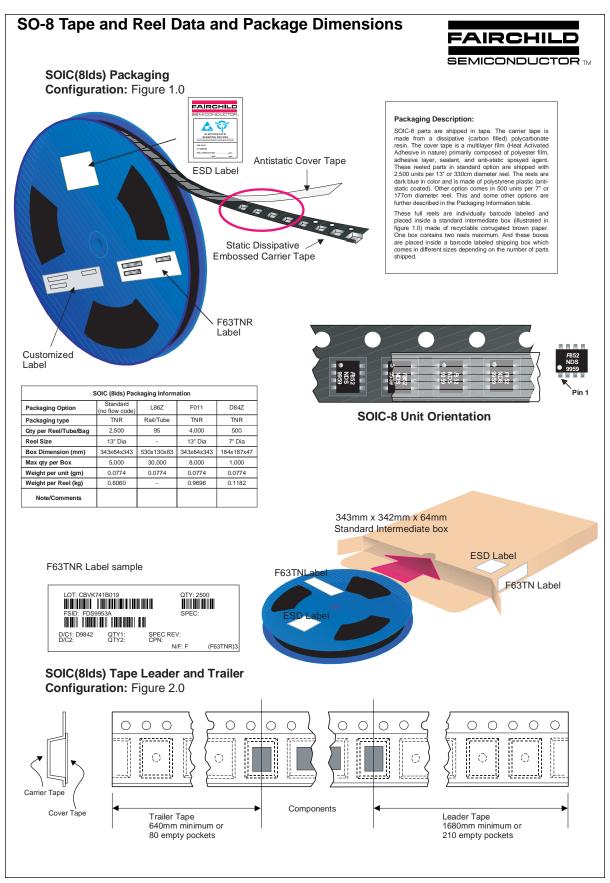
Symbol	Parameter	Conditions		Min	Тур	Max	Units
OFF CHA	RACTERISTICS						
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>gs</sub> = 0 V, I <sub>p</sub> = -250 μA		-60			V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>ps</sub> = -40 V, V <sub>gs</sub> = 0 V				-2	μA
			T <sub>J</sub> = 55°C			-25	μA
I <sub>GSSF</sub>	Gate - Body Leakage, Forward	V <sub>gs</sub> = 20 V, V <sub>ps</sub> = 0 V				100	nA
I <sub>GSSR</sub>	Gate - Body Leakage, Reverse	V <sub>gs</sub> = -20V, V <sub>ps</sub> = 0 V				-100	nA
	ACTERISTICS (Note 2)						
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{ps} = V_{qs}, I_{p} = -250 \mu A$		-1	-2.4	-3	V
.,			T <sub>J</sub> =125°C	-0.8	-2	-2.6	Ì
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance	V <sub>gs</sub> = -10 V, I <sub>p</sub> = -2.3 A			0.21	0.25	Ω
			T_=125°C		0.3	0.4	1
		V <sub>gs</sub> = -4.5 V, I <sub>p</sub> = -1.6 A			0.36	0.5	
I <sub>D(on)</sub>	On-State Drain Current	$V_{GS} = -10 \text{ V}, \text{ V}_{DS} = -5 \text{ V}$		-10			Α
9 <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> = -15 V, I <sub>D</sub> = -2.3 A			3.5		S
DYNAMIC	CHARACTERISTICS						
C <sub>iss</sub>	Input Capacitance	$V_{DS} = -25 V, V_{GS} = 0 V,$ f = 1.0 MHz			570		pF
C <sub>oss</sub>	Output Capacitance				140		pF
C <sub>rss</sub>	Reverse Transfer Capacitance				40		pF
SWITCHIN	IG CHARACTERISTICS (Note 2)						
t <sub>D(on)</sub>	Tum - On Delay Time	$V_{DD} = -30 \text{ V}, \text{ I}_{D} = -1 \text{ A},$ $V_{GEN} = -10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$			8	15	ns
ţ	Turn - On Rise Time				20	40	ns
t <sub>D(off)</sub>	Turn - Off Delay Time				20	40	ns
t <sub>r</sub>	Turn - Off Fall Time				5	20	ns
Q <sub>g</sub>	Total Gate Charge	V <sub>DS</sub> = -30 V,			16	25	nC
Q <sub>gs</sub>	Gate-Source Charge	$I_{\rm D} = -2.3 \text{ A}, V_{\rm GS} = -10 \text{ V}$			2	5	nC
Q <sub>gd</sub>	Gate-Drain Charge				4	8	nC



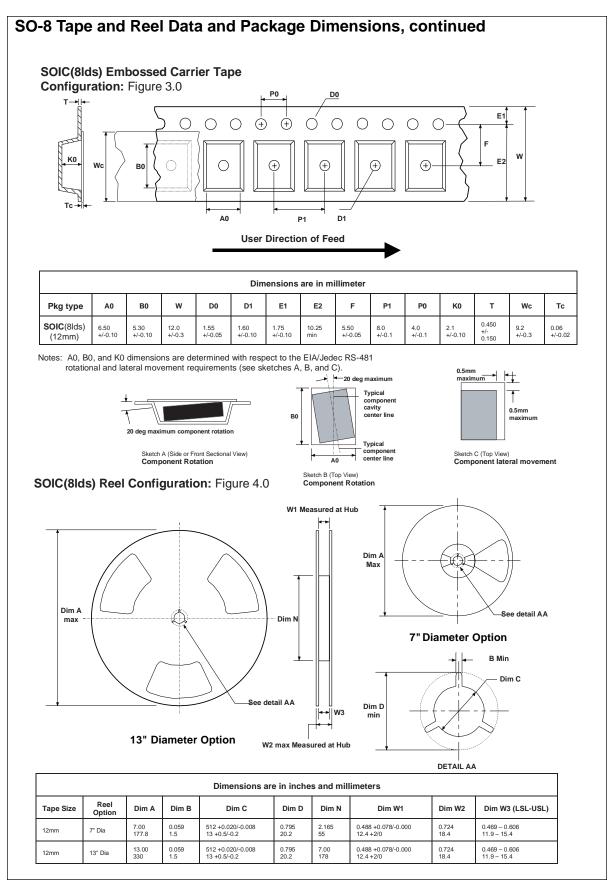


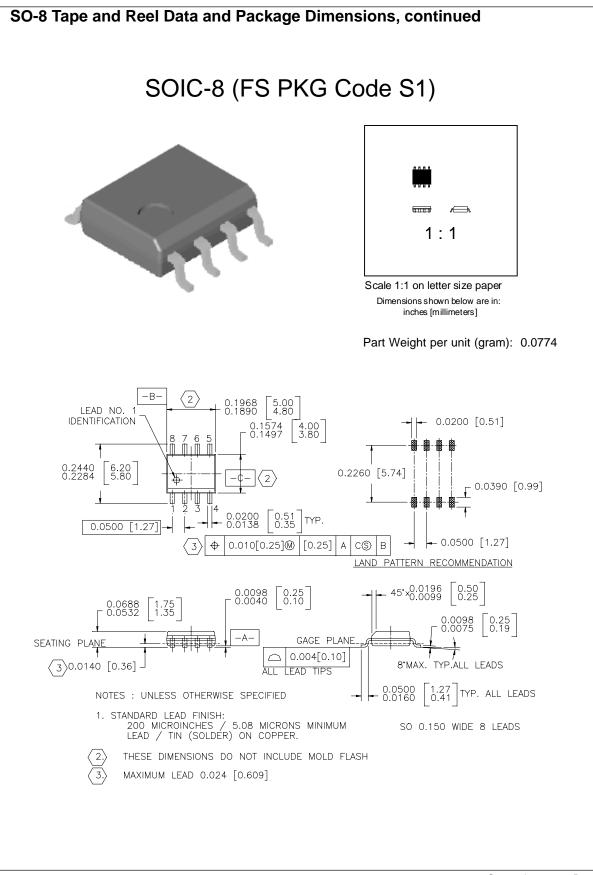






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